

SPECIFICATION FOR APPROVAL

() Preliminary	Specification
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() Final Specification

Title 7.0"W (480 X RGB X 234) TFT-LCD

BUYER	
MODEL	

SUPPLIER	LG Display Co., Ltd.
MODEL	LB070W02
SUFFIX	* TME6

^{*}Without Tcon

SIGNATURE	DATE
/	

APPROVED BY	DATE
H.S. HONG /G.Manager	2008. 12. 03
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RECORD OF REVISIONS

Revision No.	Revision Date	Page	Summary
0.1	2008.10.23	-	Preliminary
0.2	2008.11.19	5	Interface (Input terminal) symbol [addition] VCC → VDD1(VCC), AVDD → VDD2(AVDD)
		6	Wire color Anode: red → white Cathode: white → gray
		10	Sampling Mode Selection [addition]
		13	Color chromaticity Wx:0.311 \rightarrow 0.310 Wy:0.346 \rightarrow 0.340
		17	Wire Length Spec: 90 ± 5 mm \rightarrow 95 ± 5 mm Backlight Label drawing change
1.0	2008.11.20	-	Final Specification
1.1	2008.12.03	17	LCM Label position change



1. Summary

The LB070W02-TME6 is a **White LED Backlight Assembly** Product of TFT LCD without any extra system. This module utilizes amorphous silicon thin film transistors and a 16:9 aspect ratio. A 7.0" active matrix liquid crystal display allows full color to be displayed.

The applications are Portable DVD, Multimedia applications and others AV system.

2. Features

- •Utilizes a panel with a 16:9 aspect ratio, which makes the module suitable for use in wide-screen systems.
- •The 7.0" screen produces a high resolution image that is composed of 112,320 pixel elements in a stripe arrangement.
- •Wide viewing angle technology is employed.

[The most suitable viewing direction is in the 6 o'clock direction.]

- •By adopting an active matrix drive, a picture with high contrast is realized.
- •This Board Assembly is accomplished through the use of COG mounting technology.
- •By adopting a high aperture panel, high transmittance color filter and high transmission polarizing plates, transmittance ratio is realized.

3. General Specification

CHARACTERISTIC ITEM	SPECIFICATION
Video Signal Interface	Analog Video Interface
Display Technology	a-Si TFT active matrix
Display Mode	TN Type Full Color / Transmitting Type / Normally White
Screen Size (Diagonal)	7.0" (17.67cm)
Outline Dimension	164.9mm (H) X 100mm (V) X 5.7mm (D)
Active Area	154.08mm (H) X 86.58mm (V)
Number Of dots	480(H) X 3(R,G,B) X 234(V)
Dot Pitch	0.107mm (H) X 0.370mm (V)
Color Filter Array	RGB vertical stripes
Weight	Max 170g
Backlight	15LEDs
Surface Treatment	Anti-Glare Treatment



4. Interface (Input terminal)

1> TFT-LCD Panel Driving Part

Pin No.	SYMBOL	FUNCTION	REMARK
1	GND	Ground for logic circuit	
2	VDD1(VCC)	Supply voltage of logic control circuit for scan driver	
3	VGL	Negative power for scan driver	
4	VGH	Positive power for scan driver	
5	Open	Open	
6	STV	Vertical start pulse	
7	CLK	Shift clock input for scan driver	
8	U/D	Up/Down Scanning Change	See 6-3> P.10
9	GOE	Output enable input for scan driver(GOE)	H: enable / L:disable
10	VCOM	Common electrode driving signal	
11	VCOM	Common electrode driving signal	
12	L/R	LEFT/RIGHT scan control input	See 6-3> P.10
13	MOD	Sequential sampling and simultaneous sampling setting	See 6-3> P.10
14	SOE	Output enable input for data driver(INH)	
15	STHL	Start pulse for horizontal scan line	
16	STHR	Start pulse for horizontal scan line	
17	CPH3	Sampling and shifting clock pulse for data driver	
18	CPH2	Sampling and shifting clock pulse for data driver	
19	CPH1	Sampling and shifting clock pulse for data driver	
20	VCC	Supply voltage of logic control circuit for data driver	
21	GND	Ground for logic circuit	
22	VR	Alternated video signal input(Red)	
23	VG	Alternated video signal input(Green)	
24	VB	Alternated video signal input(Blue)	
25	VDD2(AVDD)	Supply voltage for analog circuit	
26	AVSS	Ground for analog circuit	

^{**}The matching connector part number is **GF053-26S-LSS(Bottom Contact Type)** or **GF055-26S-LSS**(**Top Contact Type)** manufactured by LS Cable Ltd. or equivalent.



2> Backlight Driving Part

Pin No.	SYMBOL	FUCTION	REMARK
1	Α	Power Supply For LED [Anode]	[Note 4-1]
2	К	Power Supply For LED [Cathode]	[Note 4-2]

The backlight interface connector is a model **BHSR-02VS-1** manufactured by JST or a model **1674817-1** manufactured by AMP. The matching connector part number is **SM02B-BHSS-1-TB** manufactured by JST or equivalent.

[Note 4-1] The wire color of Anode side is white.

[Note 4-2] The wire color of Cathode side is gray.



5. Absolute Maximum Ratings

PARAMETER	SYMBOL	CONDITION	MIN.	MAX.	UNIT	REMARK
Logic Voltage	VDD1	T _a =25℃	-0.5	6.0	V	
Source Driver Voltage	VDD2	T _a =25℃	-0.5	6.0	V	
Digital Input Signals	V _{DI}	T _a =25℃	-0.5	VDD1+0.5	V	[Note 5-1]
Analog Input Signals	V _{AI}	T _a =25℃	-0.5	VDD2+0.5	V	[Note 5-2]
Gate Driver High Supply Voltage	VGH	T _a =25℃	-0.5	28	V	
Gate Driver Low Supply Voltage	VGL	T _a =25℃	-16	0.5	V	
Storage Temperature	T _{st}	-	-20	70	$^{\circ}$	[Note 5-3,4]
Operating Temperature (Ambient Temperature)	T _a	-	-10	60	°C	[Note 5- 3,4,5,6]
LED Forward current	I _F	T _a =25℃	-	30	mA	[Note 5-7]
Reverse Voltage	V_R	T _a =25℃	-	5	V	[Note 5-7]

[Note 5-1] DS, U/D, STV, CLK, OE, DSOE, STH1, STH2, L/R, SOE, CPH1, CPH2, CPH3

[Note 5-2] VR, VG, VB

[Note 5-3] This rating applies to all parts of the module and should not be exceeded.

[Note 5-4] Maximum wet-bulb temperature is 60 °C. Condensation of dew must be avoided as electrical current leaks will occur, causing a degradation of performance specifications.

[Note 5-5] The operating temperature only guarantees operation of the circuit. The contrast, response speed, and the other specification related to electro-optical display quality is determined at the room temperature, $Ta = 25 \,^{\circ}\text{C}$.

[Note 5-6] Ambient temperature when the backlight is lit (reference value).

[Note 5-7] Applies for each LED individually



6. Electrical Characteristics

- 1> Recommended Operating Conditions
 - ◆ TFT-LCD Panel Driving Section

T_a=25 ℃

PARAI	METER	SYMBOL	MIN.	TYP.	MAX.	UNI T	REMARK
Logic Supp	oly Voltage	VDD1	3.0	3.3	5.5	V	
Digital Input Cignal	High Level	V _{IH}	0.8VDD1	-	VDD1	V	
Digital Input Signal	Low Level	V _{IL}	0	-	0.2VDD1	V	
Source Driver Supply Voltage		VDD2	4.5	5.0	5.5	V	
	High Supply Voltage	VGH	16.0	16.5	17.0	V	
Gate Driver	Low Supply Voltage	VGL	-15	-10	-5	V	
Analog Video Sig	nal Input Voltage	V _{VI}	AGND+1.0	-	VDD2-1.0	V	
Color Filter	AC Component	VCOM _{AC}	4.0	5.0	6.0	V _{P-P}	
Substrate Voltage	DC Component	VCOM _{DC}	-	1.75	-	V	[Note 6-1]

[Note 6-1] This value should be tuned for optimal display quality of each panel.

***** Cautionary Matter: When applying or disconnecting power, please be sure that such action is sequentially carried out for all power supplies. In addition, apply input signals only after power has been turned on.

-Source Driver:

Turn on power to VDD1 and VDD2 in this order.

Turn off power in the reverse order.

-Gate Driver :

Turn on power to VDD1, VGL and VGH in this order.

Turn off power in the reverse order.



PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	REMARK
Logic Supply Current	I _{DD1}	-	-	5.0	mA	VDD1 = 3.3V
Source Driver Supply Current	I _{DD2}	-	-	50	mA	VDD2 = 5.0V
Gate Driver High Supply Current	I _{GH}	-	-	0.5	mA	VGH=16.5V
Gate Driver Low Supply Current	I _{GL}	-	-	15	mArms	VGL _{DC} =-10V

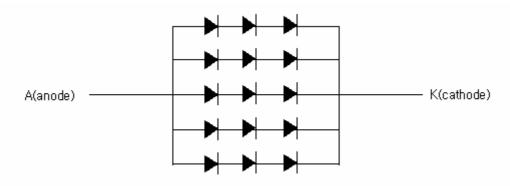
Backlight Driving Section

T_a=25 ℃

Parameter	Symbol	Min	Тур	Max	Unit	Notes
LED Forward Current	I _{BL}	1	100	-	mA	[Note 6-3]
LED Forward Voltage	V_{BL}	9.0	9.6	10.5	V	[Note 6-3]
Power Consumption	P_BL	-	0.96	1.06	Watt	

[Note 6-2] The permissible forward current of LED vary with environmental temperature.

[Note 6-3] I_{BL} do not mean a current consumption, but allowable supply current. Not only V_{BL} but also I_{BL} has to be supplied as above values.





2> Timing Characteristics of input signals

	PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	REMARK
	Clock cycle time	Tcph	100	-	2000	ns	CPHn
	CPHn pulse duty	Tcwh	40	-	60	%	CPHn
S	CPHn phase delay	Tc12 Tc23 Tc31	20	-	Tcph/2	ns	CPH1-CPH2 CPH2-CPH3 CPH3-CPH1
0 U	Set-up time of analog signals	Tasu	60	-	-	ns	VA,VB,VC-CPHn
R C	Hold time of analog signals	Tahd	40	-	-	ns	CPHn-VA,VB,VC
E	STHn set-up time	Tsu	20	-	-	ns	STHn-CPHn
	STHn hold time	Thd	10	-	-	ns	CPHn-STHn
	Propagation delay of STHn	Tphl	10	35	50	ns	CL=25pF
	Sample and hold disable time	Tdis	8	-	-	us	OE-STHn
	SOE pulse width	Twoe	1	-	-	Tcph	
	Clock Frequency	f _{CL}	-	-	500	KHz	
	Clock Pulse Width	T _{CWH} T _{CWL}	500 500	-	-	ns	
G	OE Disable Time	T_{WOEB}	1000	-	-	ns	
A	STV Setup Time	T _{SUSTV}	200	-	-	ns	
T E	STV Hold Time	T _{HDSTV}	200	-	-	ns	
	Output Delay to CL	T_{pd1r}	ı	-	800	ns	CL=300pF
	Output Delay to CL	T_{pd1f}	ı	-	800	ns	CL=300pF
	Output Delay to OE	T_{pd2r}	ı	-	800	ns	CL=300pF
	Output Delay to OE	T_{pd2f}	-	-	800	ns	CL=300pF

3> Scanning Mode Selection (Reference position : @ Input terminal)

MODE	L/R	U/D	STHL	STHR	STV	REMARK
Normal Mode	Н	Н	Signal Output	Signal Input	Input	
Left/Right Reverse Mode	L	Н	Signal Input	Signal Output	Input	See P.14 (the figure of
Up/Down Reverse Mode	Н	L	Signal Output	Signal Input	Input	[Note 7-3])
Left/Right & Up/Down Reverse Mode	L	L	Signal Input	Signal Output	Input	

^{*****} H(High Level) = VDD1, L(Low Level) = DGND

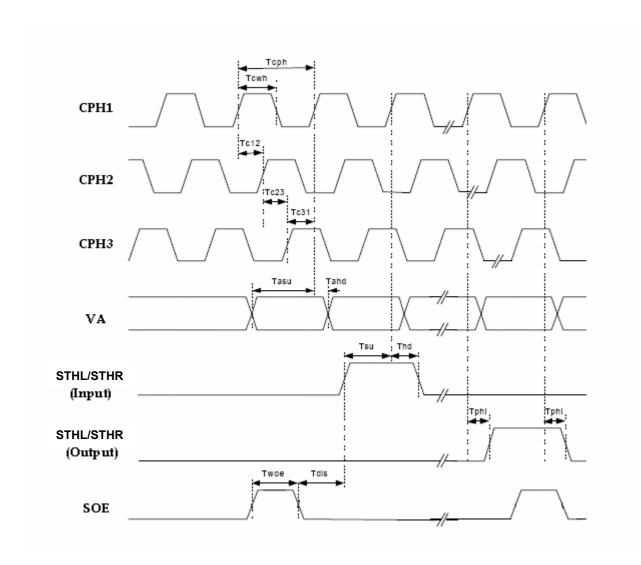
4> Sampling Mode Selection (Reference position : @ Input terminal)

MOD	H (High Level)	L (Low Level)
MODE	Simultaneous Sampling Mode	Sequential Sampling Mode

^{******} Remark: When MOD= "H", CPH2 and CPH3 must be shorted to VDD1 or GND



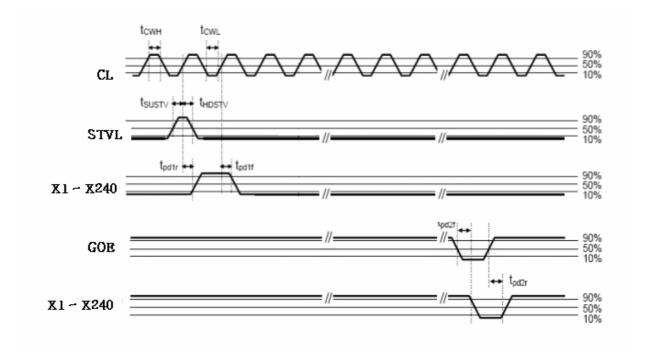
Timing for a Source Driver



- Remark : The sample-and-hold circuits are switched and the outputs are started with new data at the rising edge of SOE.
 - " For Twoe period, shift register in source driver are reset internally."



Switching Characteristics Waveform for Gate Driver



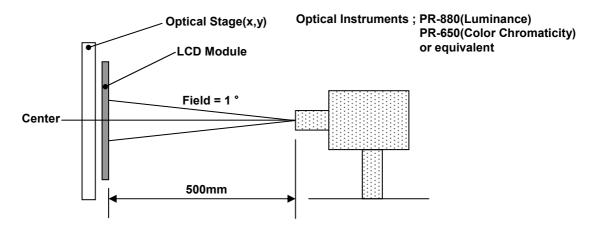


7. Electro-optical Characteristics

T_a=25℃

PARAMI	ETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
Lumina	ince	L _{WH}	I _{BL} =100mA	160	200	-	cd/m ²	[Note 7-1]
Contrast	Ratio	CR	Optimal	300	400	-	-	[Note 7-2]
Luminance '	Luminance Variation		-	-	1.25	1.35	-	[Note 7-5]
White C	Color	W _x		0.260	0.310	0.360	-	[Note 7 1]
Chroma	ticity	W _y	-	0.290	0.340	0.390	-	[Note 7-1]
	φ=180°	ΘI		60	65	-	o	
Viewing	ф=0°	⊝r		60	65	-	o	[Note 7-2]
Angle	ф=90°	⊖u	CR≥10	40	45	-	0	[Note 7-3]
	ф=270°	⊖d		50	55	-	0	
Response	sponse Rise τ_r		⊝=0°	-	10	20	ms	[Noto 7 4]
Time	Fall	$\tau_{\sf d}$	□− 0	-	20	30	ms	[Note 7-4]

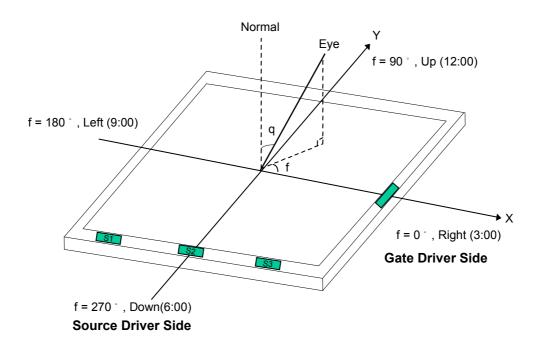




Measuring Condition;

- -Measuring surroundings : Dark Room
- -Measuring temperature : T₂=25 °C
- -Adjust operating voltage to get optimum contrast at the center of the display.
- -Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.
- [Note 7-1] Measured on the center area of the panel by PHOTO RESEARCH photometer PR-880, PR650. [Note 7-2] Contrast ratio is defined as follows;

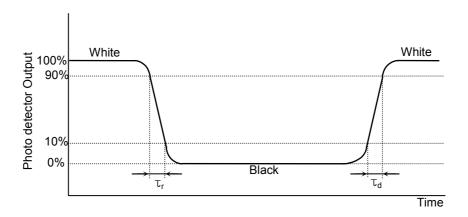
[Note 7-3] Viewing angle range is defined as follows;





[Note 7-4]

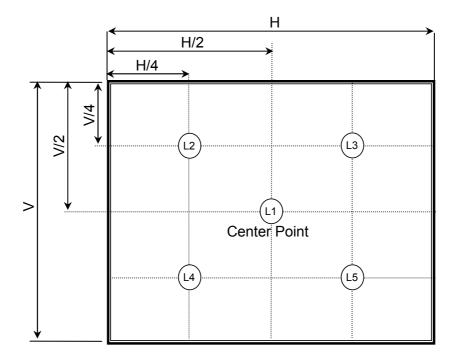
Response time is obtained by measuring the transition time of photo detector output, when input signals are applied so as to make the area "black" to and from "white".



[Note 7-5]

<measuring point for surface luminance & measuring point for luminance variation>

$$\delta_{WHITE}$$
 = Maximum(L1,L2, L5) \div Minimum(L1,L2, L5)



H,V: ACTIVE AREA



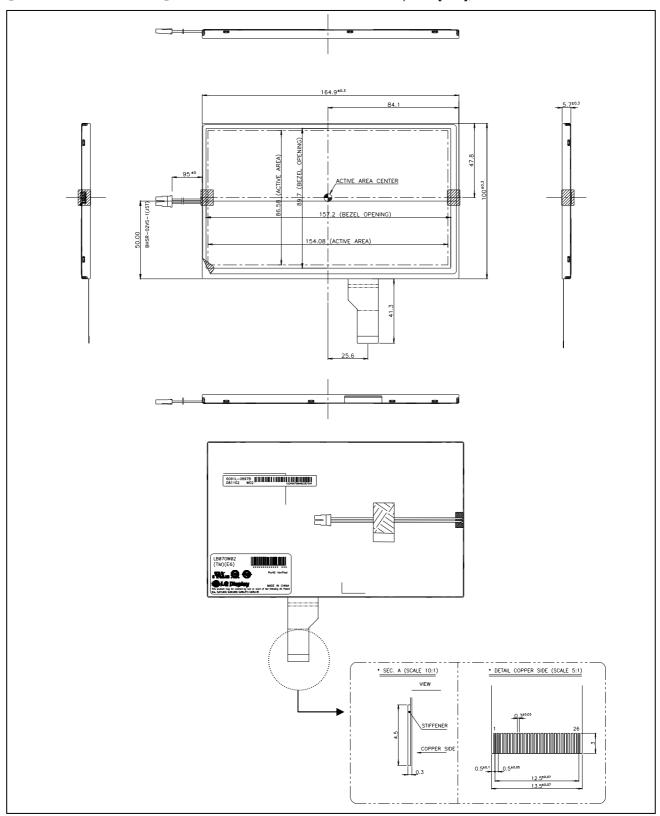
8. Mechanical Characteristics

PARAMETER		SPECIFICATION	UNIT	REMARK
	Horizontal	164.9	mm	±0.3
Outline Dimension	Vertical	100	mm	±0.3
	Depth	5.7	mm	±0.3
Active Diaplay Area	Horizontal	154.08	mm	
Active Display Area	Vertical	86.58	mm	
Weight		Max 170	g	
Surface Treatment	Д	Anti-Glare Treatment	-	



[Outline Dimension]

Note) Unit:[mm], General tolerance: ± 0.3mm





9. Reliability Test

No.	Test Items	Test Condition	REMARK
1	High Temperature Storage Test	Ta=70℃ 240h	[Note 9-1,2,3]
2	Low Temperature Storage Test	Ta=-20℃ 240h	[Note 9-1,2,3]
3	High Temperature Operation Test	Ta=60℃ 240h	[Note 9-1,2,3]
4	Low Temperature Operation Test	Ta=-10℃ 240h	[Note 9-1,2,3]
5	High Temperature and High Humidity Operation Test	Ta=50℃ 80%RH 240h	[Note 9-1,2,3]
6	Electro Static Discharge Test	-Panel Surface/Top_Case $: 150 pF, 150 \Omega \\ (Air: \pm 15 kV, Contact: \pm 8 kV)$ -FPC input terminal: $100 pF \pm 200 V 0 \Omega$	
7	Shock Test (non-operating)	Half sine wave, 80G, 11ms 3 times shock of each six faces	
8	Vibration Test (non-operating)	Sine wave, 10 ~ 500 ~ 10Hz, 1.5G, 0.37oct/min 3 axis, 1hour/axis	
9	Thermal Shock Test	-10 °C (0.5h) ~ 60 °C (0.5h) / 100 cycles	

[Note 9-1] T_a = Ambient Temperature

[Note 9-2] In the Reliability Test, Confirm performance after leaving in room temp.

[Note 9-3] In the standard condition, there shall be no practical problems that may affect the display function. After the reliability test, we can guarantee the product only when the corrosion is causing its malfunction. The corrosion causing no functional defect can not be guaranteed.



10. International Standards

10-1. Safety

- a) UL 60950-1:2003, First Edition, Underwriters Laboratories, Inc., Standard for Safety of Information Technology Equipment.
- b) CAN/CSA C22.2, No. 60950-1-03 1st Ed. April 1, 2003, Canadian Standards Association, Standard for Safety of Information Technology Equipment.
- c) EN 60950-1:2001, First Edition, European Committee for Electrotechnical Standardization(CENELEC) European Standard for Safety of Information Technology Equipment.

10-2. EMC

- a) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHZ to 40GHz. "American National Standards Institute(ANSI), 1992
- b) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special Committee on Radio Interference.
- c) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization.(CENELEC), 1998 (Including A1: 2000)



11. Packing

11-1. Designation of Lot Mark

a) Lot Mark

А	В	С	D	E	F	G	Н	I	J	К	L	М
---	---	---	---	---	---	---	---	---	---	---	---	---

A,B,C : SIZE(INCH) D : YEAR

E: MONTH $F \sim M$: SERIAL NO.

Note

1. YEAR

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010
i cai	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020
Mark	1	2	3	4	5	6	7	8	9	0

2. MONTH

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Mark	1	2	3	4	5	6	7	8	9	Α	В	С

b) Location of Lot Mark

Serial No. is printed on the label. The label is attached to the backside of the LCD module. This is subject to change without prior notice.

11-2. Packing Form

a) Package quantity in one box: 36 pcs

b) Box Size(mm): 475(L)×348(W)×182(H)



12. PRECAUTIONS

Please pay attention to the following when you use this TFT LCD module.

12-1. MOUNTING PRECAUTIONS

- (1) You must mount a module using hole arranged in the side.
- (2) You should consider the mounting structure so that uneven force(ex. Twisted stress) is not applied to the module.
 - And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach a transparent protective plate to the surface in order to protect the polarizer.

 Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth.(Some cosmetics deteriorate the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzine. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.
- (10) The metal case of a module should be contacted to electrical ground of your system.

12-2. OPERATING PRECAUTIONS

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage : $V=\pm 200 \text{mV}(\text{Over and under shoot voltage})$
- (2) Response time depends on the temperature.(In lower temperature, it becomes longer.)
- (3) Brightness depends on the temperature. (In lower temperature, it becomes lower.)

 And in lower temperature, response time(required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimized the interference.



12-3. ELECTROSTATIC DISCHARGE CONTROL

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

12-4. PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of polarizer and color filter.

12-5. STORAGE

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object.

 It is recommended that they be stored in the container in which they were shipped.

12-6. HANDLING PRECAUTIONS FOR PROTECTION FILM

- (1) When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) The protection film is attached to the polarizer with a small amount of glue. If some stress is applied to rub the protection film against the polarizer during the time you peel off the film, the glue is apt to remain on the polarizer.
 - Please carefully peel off the protection film without rubbing it against the polarizer.
- (3) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the polarizer after the protection film is peeled off.
- (4) You can remove the glue easily. When the glue remains on the polarizer surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.